

BB503C

Build in Biasing Circuit MOS FET IC
UHF RF Amplifier

HITACHI

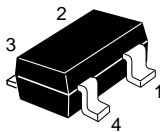
ADE-208-812C (Z)
4th. Edition
Mar. 2001

Features

- Build in Biasing Circuit; To reduce using parts cost & PC board space.
- Low noise; NF = 1.8 dB typ. at f = 900 MHz
- High gain; PG = 22 dB typ. at f = 900 MHz
- Withstanding to ESD;
Build in ESD absorbing diode. Withstand up to 200V at C=200pF, Rs=0 conditions.
- Provide mini mold packages; CMPAK-4(SOT-343mod)

Outline

CMPAK-4



1. Source
2. Gate1
3. Gate2
4. Drain

- Notes:
1. Marking is "CS-".
 2. BB503C is individual type number of HITACHI BBFET.

BB503C

Absolute Maximum Ratings (Ta = 25°C)

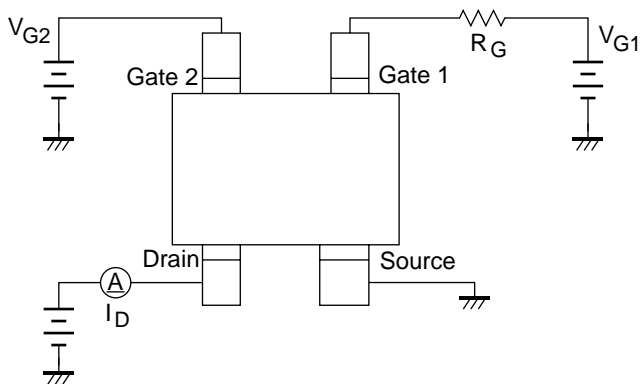
| Item | Symbol | Ratings | Unit |
|---------------------------|-----------|-------------|------|
| Drain to source voltage | V_{DS} | 6 | V |
| Gate1 to source voltage | V_{G1S} | +6 -0 | V |
| Gate2 to source voltage | V_{G2S} | +6 -0 | V |
| Drain current | I_D | 20 | mA |
| Channel power dissipation | Pch | 100 | mW |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Electrical Characteristics (Ta = 25°C)

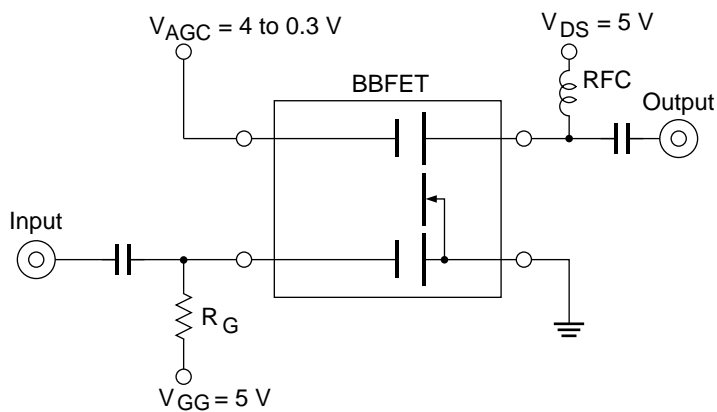
| Item | Symbol | Min | Typ | Max | Unit | Test Conditions |
|-----------------------------------|----------------|-----|-------|------|------|---|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | 6 | — | — | V | $I_D = 200\mu A$ $V_{G1S} = V_{G2S} = 0$ |
| Gate1 to source breakdown voltage | $V_{(BR)G1SS}$ | +6 | — | — | V | $I_{G1} = +10\mu A$ $V_{G2S} = V_{DS} = 0$ |
| Gate2 to source breakdown voltage | $V_{(BR)G2SS}$ | +6 | — | — | V | $I_{G2} = +10\mu A$ $V_{G1S} = V_{DS} = 0$ |
| Gate1 to source cutoff current | I_{G1SS} | — | — | +100 | nA | $V_{G1S} = +5V$ $V_{G2S} = V_{DS} = 0$ |
| Gate2 to source cutoff current | I_{G2SS} | — | — | +100 | nA | $V_{G2S} = +5V$ $V_{G1S} = V_{DS} = 0$ |
| Gate1 to source cutoff voltage | $V_{G1S(off)}$ | 0.5 | 0.7 | 1.0 | V | $V_{DS} = 5V, V_{G2S} = 4V$ $I_D = 100\mu A$ |
| Gate2 to source cutoff voltage | $V_{G2S(off)}$ | 0.5 | 0.7 | 1.0 | V | $V_{DS} = 5V, V_{G1S} = 5V$ $I_D = 100\mu A$ |
| Drain current | $I_{D(op)}$ | 7 | 10 | 13 | mA | $V_{DS} = 5V, V_{G1} = 5V$ $V_{G2S} = 4V, R_G = 47k\Omega$ |
| Forward transfer admittance | $ y_{fs} $ | 19 | 24 | 29 | mS | $V_{DS} = 5V, V_{G1} = 5V$ $V_{G2S} = 4V$ $R_G = 47k\Omega, f = 1kHz$ |
| Input capacitance | C_{iss} | 1.4 | 1.7 | 2.0 | pF | $V_{DS} = 5V, V_{G1} = 5V$ |
| Output capacitance | C_{oss} | 0.7 | 1.1 | 1.5 | pF | $V_{G2S} = 4V, R_G = 47k\Omega$ |
| Reverse transfer capacitance | C_{rss} | — | 0.025 | 0.05 | pF | $f = 1MHz$ |
| Power gain | PG | 17 | 22 | — | dB | $V_{DS} = 5V, V_{G1} = 5V$ $V_{G2S} = 4V, R_G = 47k\Omega$ |
| Noise figure | NF | — | 1.8 | 2.4 | dB | $f = 900MHz$ |

Main Characteristics

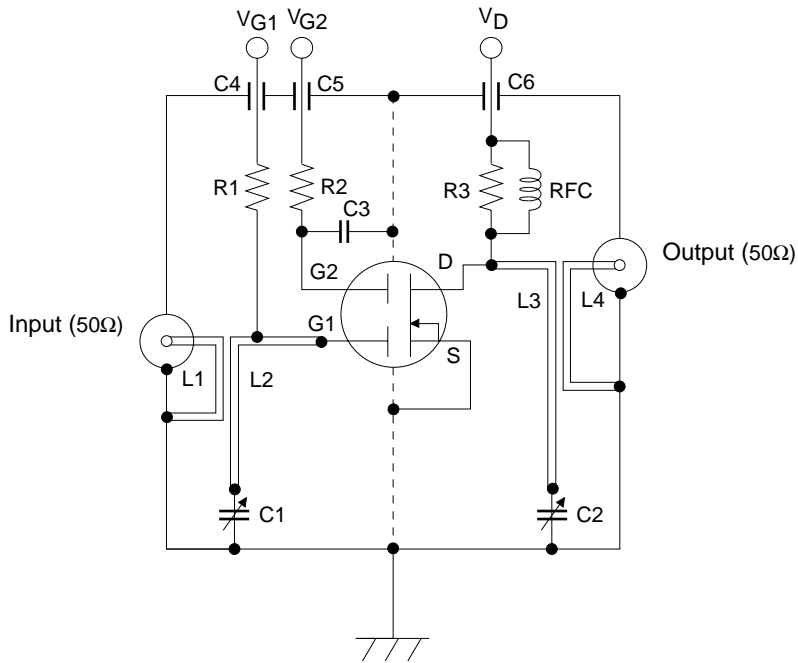
Test Circuit for Operating Items ($I_{D(op)}$, $|y_{fs}|$, C_{iss} , C_{oss} , C_{rss} , NF, PG)



Application Circuit

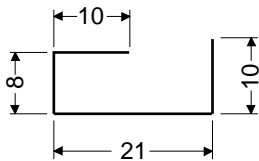


900MHz Power Gain, Noise Figure Test Circuit

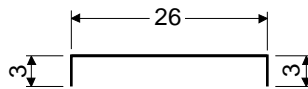


- C1, C2: Variable Capacitor (10pF MAX)
- C3: Disk Capacitor (1000pF)
- C4 to C6: Air Capacitor (1000pF)
- R1: 47 kΩ
- R2: 47 kΩ
- R3: 4.7 kΩ

L1:

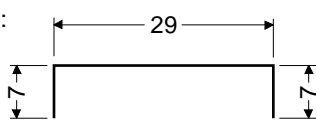


L2:

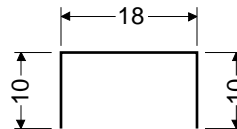


(ϕ 1mm Copper wire)
Unit: mm

L3:

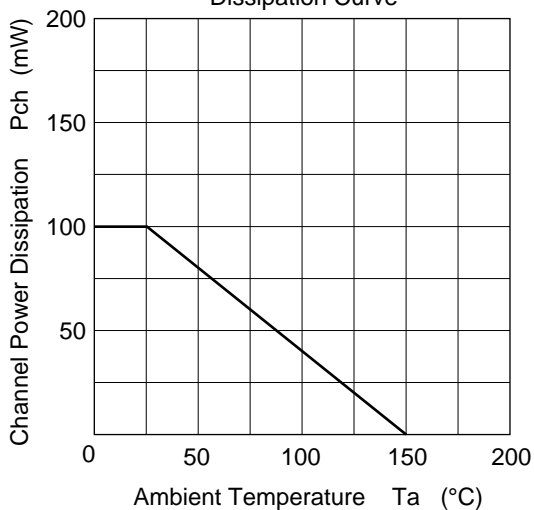


L4:

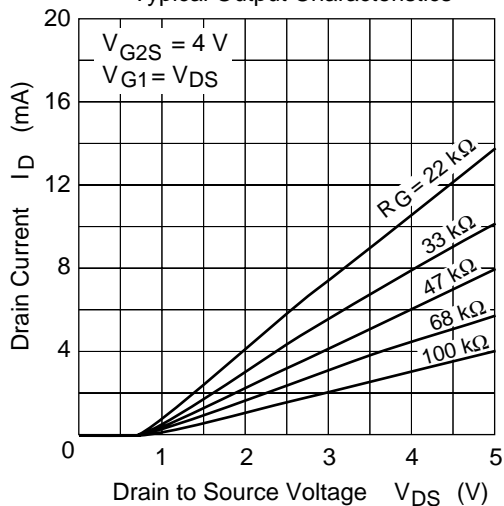


RFC: ϕ 1mm Copper wire with enamel 4turns inside dia 6mm

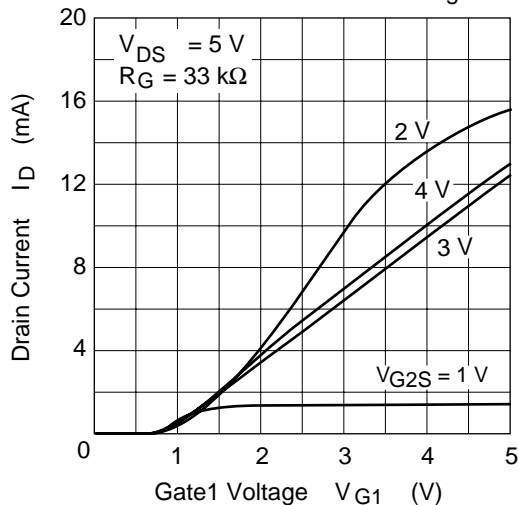
Maximum Channel Power Dissipation Curve



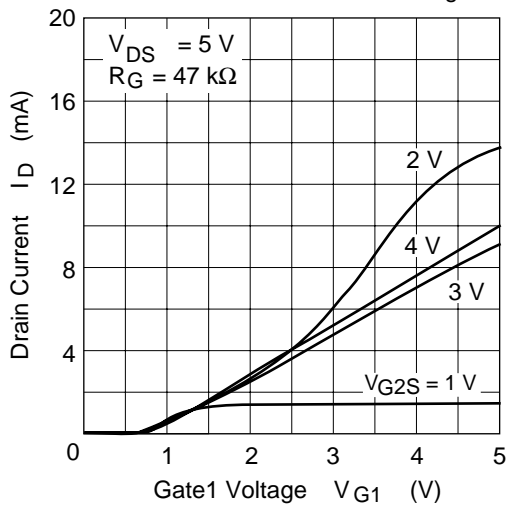
Typical Output Characteristics

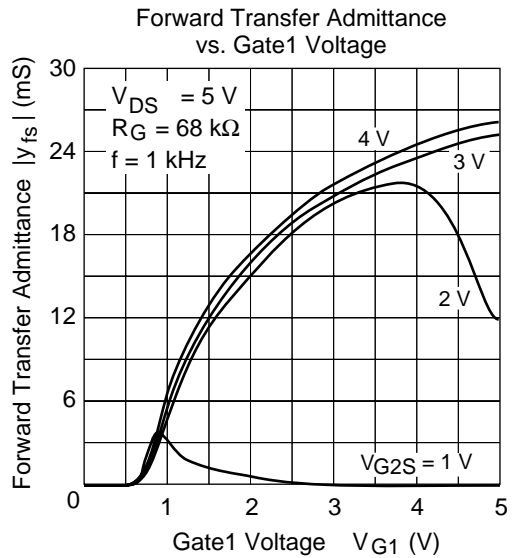
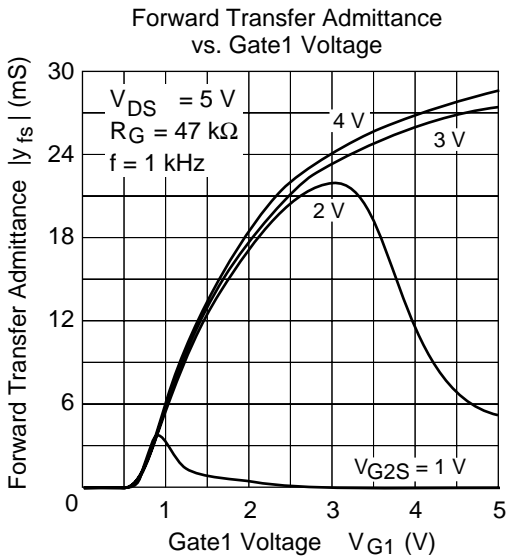
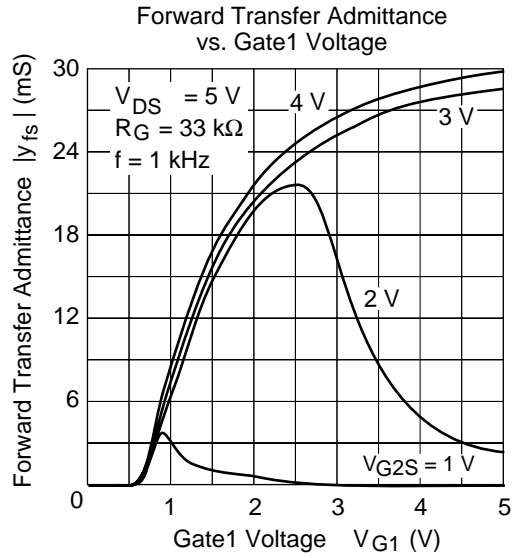
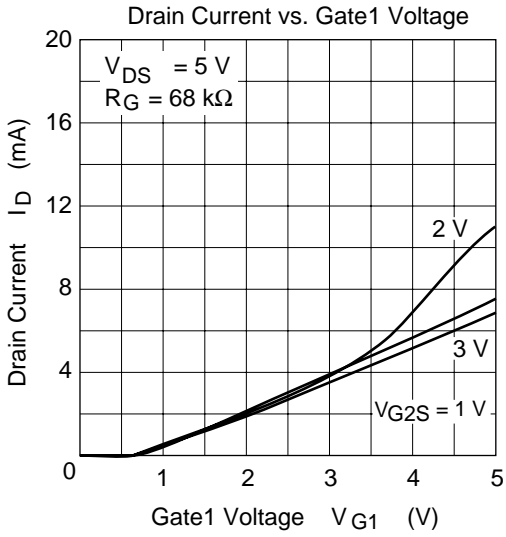


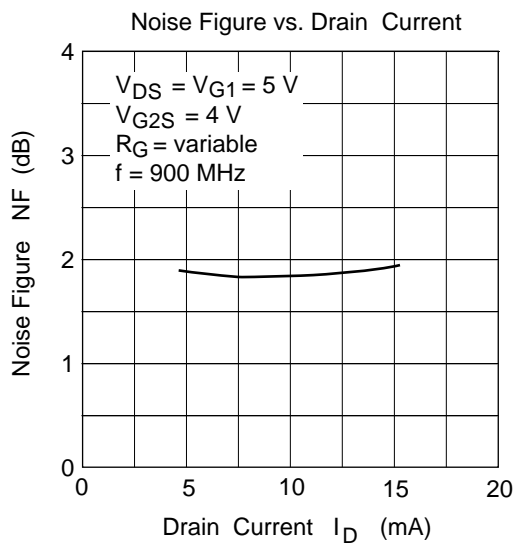
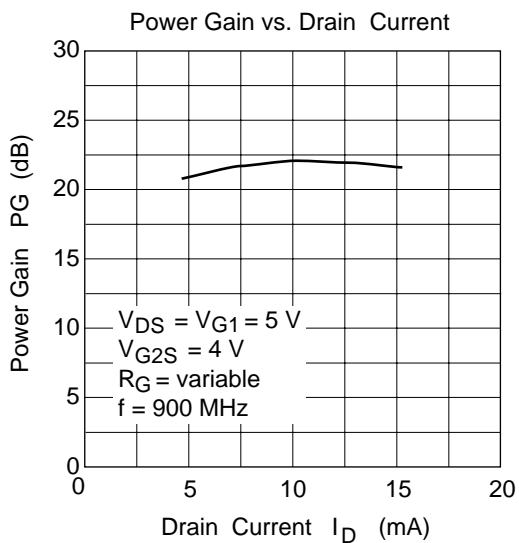
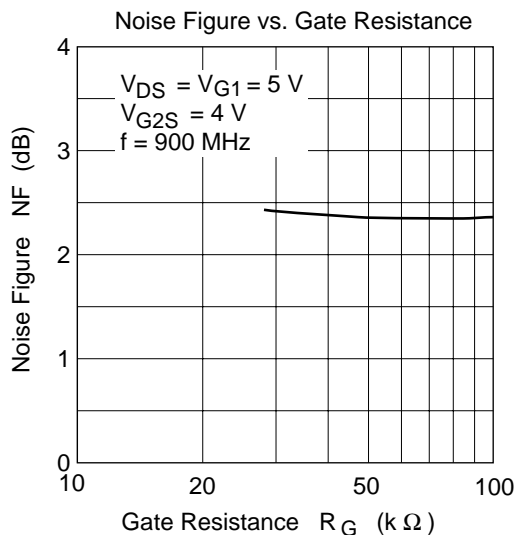
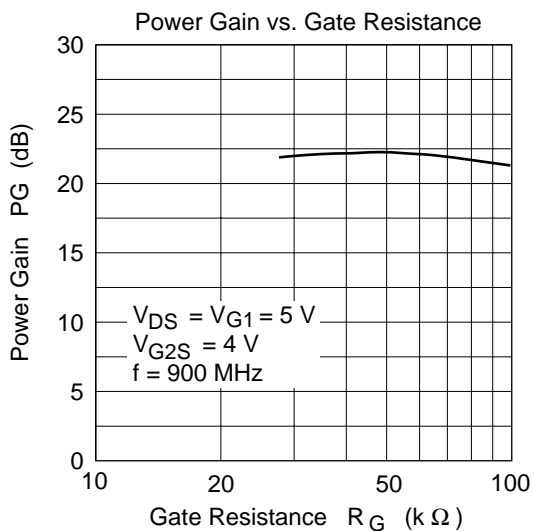
Drain Current vs. Gate1 Voltage



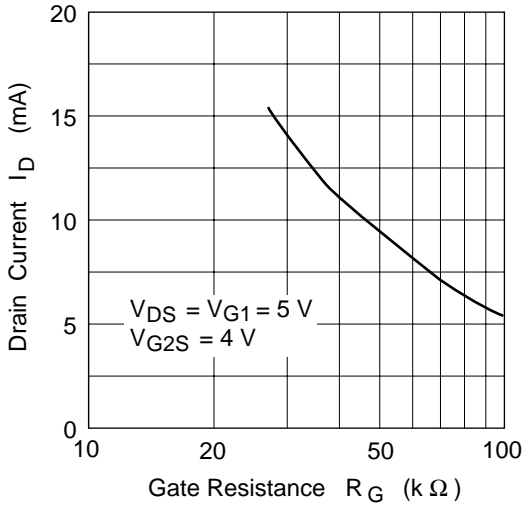
Drain Current vs. Gate1 Voltage



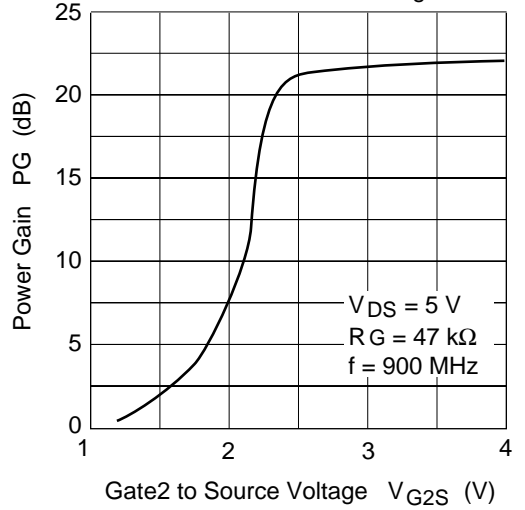




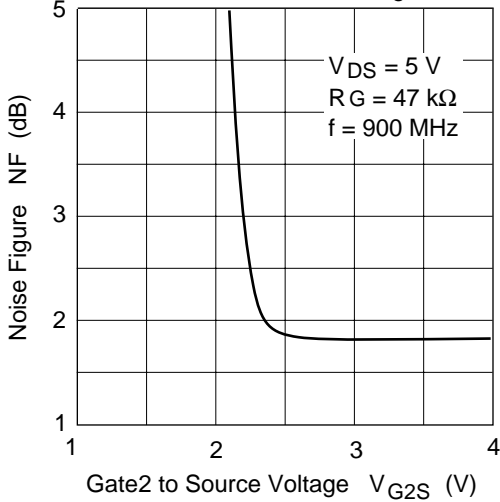
Drain Current vs. Gate Resistance



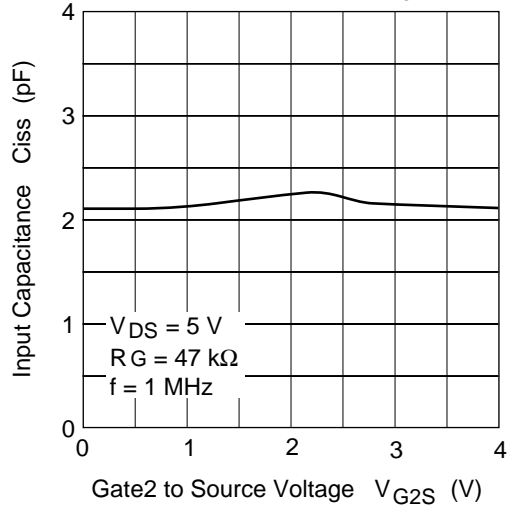
Power Gain vs. Gate2 to Source Voltage



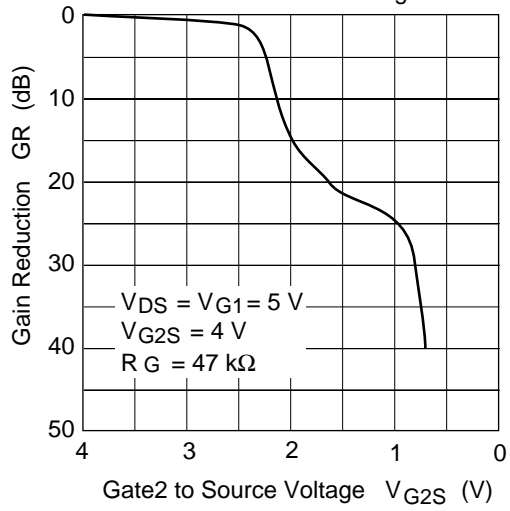
Noise Figure vs. Gate2 to Source Voltage



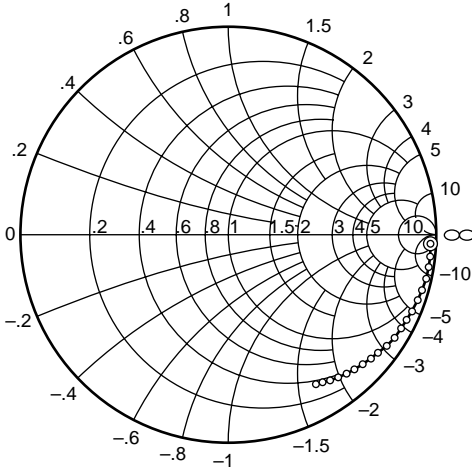
Input Capacitance vs. Gate2 to Source Voltage



Gain Reduction vs.
Gate2 to Source Voltage



S11 Parameter vs. Frequency

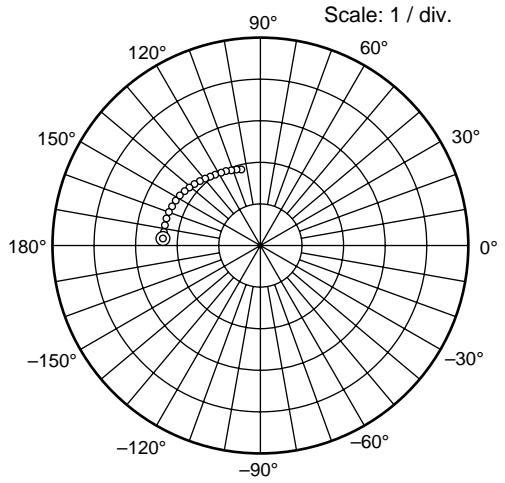


Test Condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$
 $V_{G2S} = 4\text{ V}$, $R_G = 47\text{ k}\Omega$,
 $Z_o = 50\ \Omega$

50 to 1000 MHz (50 MHz step)



S21 Parameter vs. Frequency

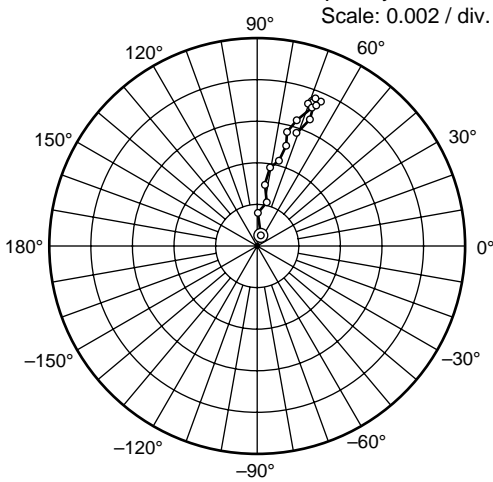


Test Condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$
 $V_{G2S} = 4\text{ V}$, $R_G = 47\text{ k}\Omega$,
 $Z_o = 50\ \Omega$

50 to 1000 MHz (50 MHz step)



S12 Parameter vs. Frequency

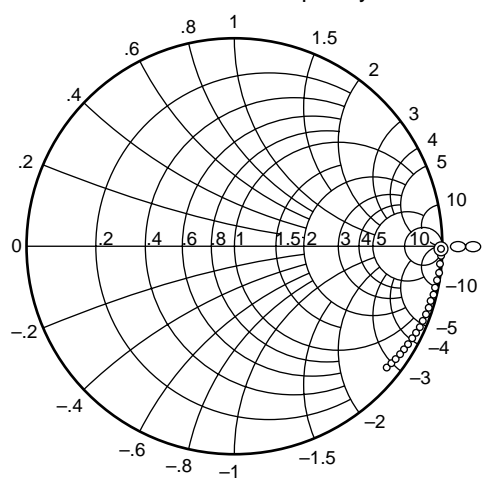


Test Condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$
 $V_{G2S} = 4\text{ V}$, $R_G = 47\text{ k}\Omega$,
 $Z_o = 50\ \Omega$

50 to 1000 MHz (50 MHz step)



S22 Parameter vs. Frequency



Test Condition: $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$
 $V_{G2S} = 4\text{ V}$, $R_G = 47\text{ k}\Omega$,
 $Z_o = 50\ \Omega$

50 to 1000 MHz (50 MHz step)



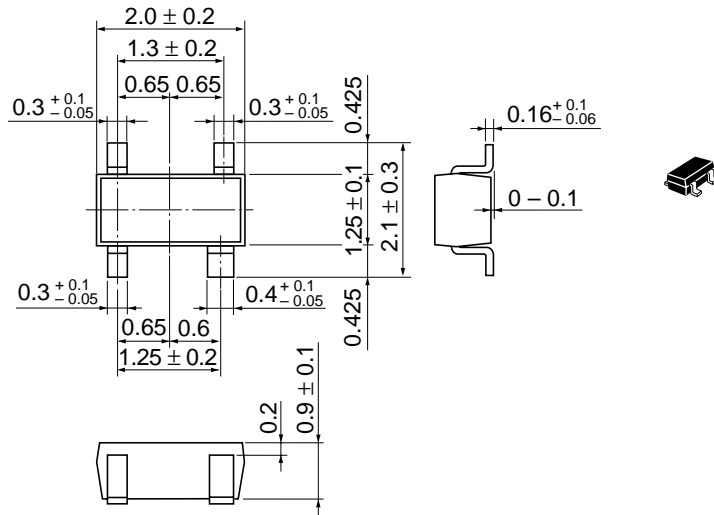
Sparameter ($V_{DS} = V_{G1} = 5V$, $V_{G2S} = 4V$, $R_G = 47k\Omega$, $Z_O = 50\Omega$)

| f (MHz) | S11 | | S21 | | S12 | | S22 | |
|---------|-------|-------|------|-------|---------|------|-------|-------|
| | MAG | ANG | MAG | ANG | MAG | ANG | MAG | ANG |
| 50 | 0.975 | -2.6 | 2.37 | 176.1 | 0.00097 | 74.4 | 0.995 | -1.9 |
| 100 | 0.977 | -6.5 | 2.37 | 172.1 | 0.00162 | 89.8 | 0.998 | -3.9 |
| 150 | 0.975 | -9.1 | 2.36 | 168.0 | 0.00222 | 78.2 | 0.997 | -5.8 |
| 200 | 0.972 | -12.4 | 2.33 | 163.8 | 0.00282 | 83.8 | 0.996 | -8.0 |
| 250 | 0.968 | -15.6 | 2.32 | 159.9 | 0.00388 | 81.1 | 0.994 | -10.0 |
| 300 | 0.963 | -18.9 | 2.30 | 156.0 | 0.00437 | 76.0 | 0.993 | -11.8 |
| 350 | 0.954 | -22.2 | 2.28 | 151.8 | 0.00518 | 73.6 | 0.991 | -13.9 |
| 400 | 0.946 | -25.3 | 2.25 | 148.2 | 0.00567 | 75.6 | 0.989 | -15.8 |
| 450 | 0.937 | -28.2 | 2.22 | 144.1 | 0.00631 | 72.5 | 0.986 | -17.8 |
| 500 | 0.930 | -31.5 | 2.19 | 140.2 | 0.00637 | 72.7 | 0.984 | -19.6 |
| 550 | 0.920 | -34.7 | 2.16 | 136.3 | 0.00720 | 70.3 | 0.981 | -21.6 |
| 600 | 0.914 | -37.4 | 2.13 | 132.7 | 0.00747 | 67.0 | 0.978 | -23.4 |
| 650 | 0.902 | -40.4 | 2.09 | 129.3 | 0.00738 | 69.2 | 0.975 | -25.4 |
| 700 | 0.886 | -43.5 | 2.07 | 125.4 | 0.00758 | 68.6 | 0.972 | -27.3 |
| 750 | 0.879 | -46.1 | 2.03 | 122.0 | 0.00757 | 66.0 | 0.968 | -29.0 |
| 800 | 0.873 | -48.9 | 1.99 | 118.3 | 0.00729 | 67.5 | 0.966 | -31.0 |
| 850 | 0.857 | -52.0 | 1.96 | 114.9 | 0.00723 | 68.8 | 0.962 | -32.9 |
| 900 | 0.845 | -54.5 | 1.93 | 111.4 | 0.00706 | 68.3 | 0.959 | -34.8 |
| 950 | 0.838 | -57.2 | 1.90 | 108.1 | 0.00659 | 67.5 | 0.954 | -36.6 |
| 1000 | 0.824 | -59.6 | 1.86 | 104.9 | 0.00574 | 71.0 | 0.952 | -38.5 |

Package Dimensions

As of January, 2001

Unit: mm



| | |
|------------------------|------------|
| Hitachi Code | CMPAK-4(T) |
| JEDEC | — |
| EIAJ | Conforms |
| Mass (reference value) | 0.006 g |

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